

Surface Mount Schottky Barrier Rectifier

Reverse Voltage - 100 V

Forward Current - 3 A

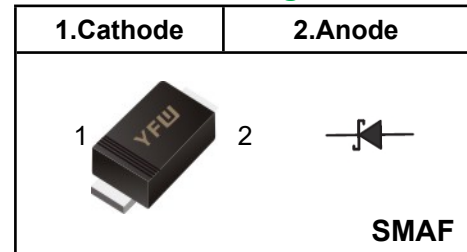
FEATURES

- ◆Metal silicon junction, majority carrier conduction
- ◆For surface mounted applications
- ◆Low power loss, high efficiency
- ◆High forward surge current capability
- ◆For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- ◆Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

- ◆Case: SMAF
- ◆Terminals: Solderable per MIL-STD-750, Method 2026
- ◆Approx. Weight: 27mg / 0.00095oz

Pinning



Marking Code

SSL310F	YFW SL310
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Absolute Maximum Ratings and Electrical characteristics

Ratings at 25 ° ambient temperature unless otherwise specified.Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

Parameter	Symbols	SSL310F	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	100	V
Maximum RMS voltage	V_{RMS}	70	V
Maximum DC Blocking Voltage	V_{DC}	100	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	3.0	A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed On Rated Load (JEDEC method)	I_{FSM}	100	A
Maximum Instantaneous Forward Voltage at 3 A	V_F	0.6	V
Maximum Instantaneous Reverse Current at Rated DC Reverse Voltage	I_R	0.1	mA
		<small>$T_A = 25^{\circ}C$ $T_A = 100^{\circ}C$</small>	
Typical Junction Capacitance ⁽¹⁾	C_j	180	pF
Typical Thermal Resistance ⁽²⁾	$R_{\theta JA}$	65	°C/W
Operating Junction Temperature Range	T_j	-55 ~ +150	°C
Storage Temperature Range	T_{stg}	-55 ~ +150	°C

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Fig.1 Forward Current Derating Curve

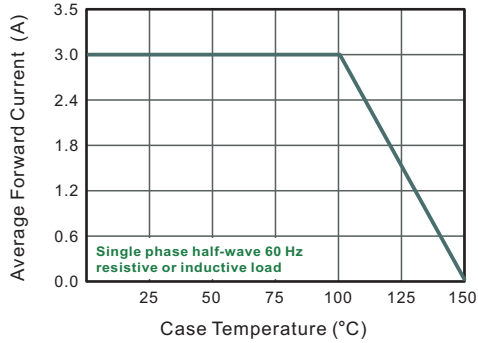


Fig.2 Typical Reverse Characteristics

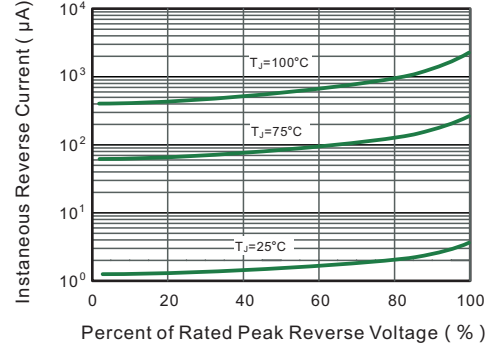


Fig.3 Typical Forward Characteristic

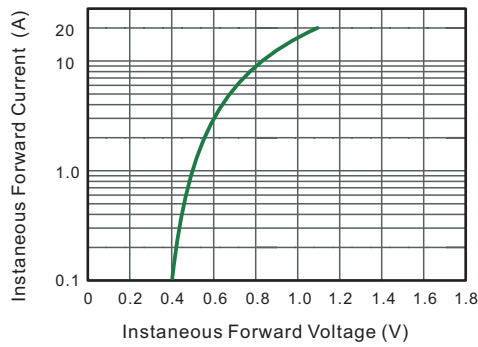


Fig.4 Typical Junction Capacitance

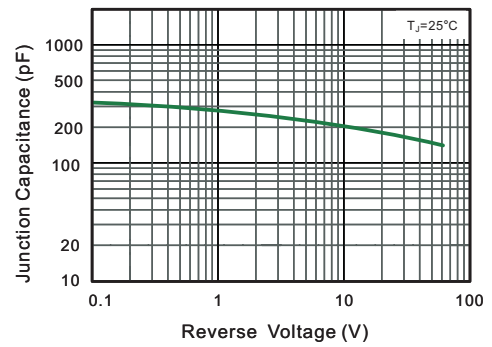


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

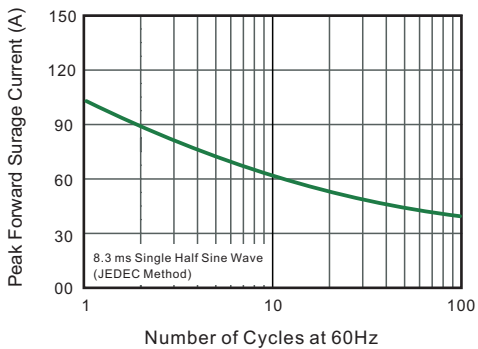
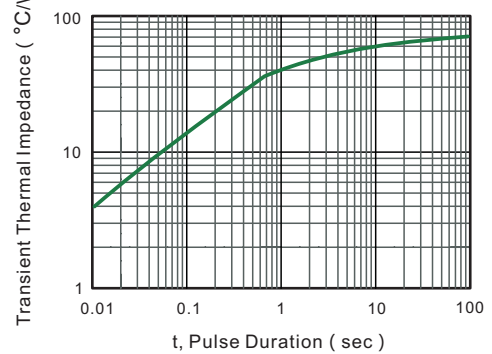


Fig.5- Typical Transient Thermal Impedance



Marking Diagram



Ordering information

Package	Packing Description	Packing Quantity
SMAF	Tape/Reel, 13" reel	10000PCS/Reel 100000PCS/Carton
	Tape/Reel, 7" reel	3000PCS/Reel 120000PCS/Carton

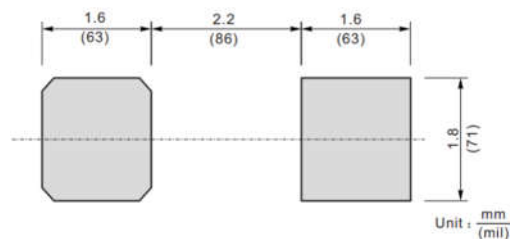
Package Dimensions

SMAF

Dim.	Millimeter(mm)		mil	
	Min.	Max.	Min.	Max.
A	0.9	1.1	35	43
C	0.12	0.20	4.7	7.9
D	3.3	3.7	130	146
E	2.4	2.7	94	106
e	1.3	1.6	51	63
g	0.8	1.2	31	47
HE	4.4	4.9	173	193
∠	7°			

The drawings show the package from the top and bottom. The top view labels dimensions D, E, HE, and ∠. The bottom view labels dimensions e and g. The side view labels dimensions A and C. All corners are noted as 'ALL ROUND'.

The recommended mounting pad size



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